

Title (en)

METHOD FOR FITTING A SUBSTRATE WITH COMPONENTS

Title (de)

VERFAHREN ZUM BESTÜCKEN VON SUBSTRATEN MIT BAUELEMENTEN

Title (fr)

PROCEDE POUR EQUIPER DES SUBSTRATS AVEC DES COMPOSANTS

Publication

**EP 1181854 B1 20021204 (DE)**

Application

**EP 00940198 A 20000517**

Priority

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Abstract (en)

[origin: WO0074462A1] When components to be inserted on a substrate are distributed across several processing zones (6, 11) arranged in a line, inconvenient down times result if only few components are to be inserted since this entails the additional measurement of markings on the substrates (1) and the quantization of a large number of holding devices (5) on the insertion head (4). According to the invention, if only few components are to be inserted all of these components are inserted in one processing zone (6). If several transport devices (7, 12) are used this results in several independently operating insertion lines.

IPC 1-7

**H05K 13/04**

IPC 8 full level

**H05K 13/04** (2006.01)

CPC (source: EP KR US)

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